

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
David Xuan-Qi Wang	06/04/2010
Mehrdad Moslehi	06/04/2010
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<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	95035
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12731058
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<b>NAME OF SUBMITTER:</b>	William N. Hulsey III
<b>Total Attachments: 2</b> source=SOLT034US1_Assignment_Executed_2#page1.tif source=SOLT034US1_Assignment_Executed_2#page2.tif	

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**ASSIGNMENT**

This Assignment is made by David Xuan-Qi Wang of Fremont, California and Mehrdad M. Moslehi of Los Altos, California (hereinafter referred to as "Assignor").

WHEREAS, Assignor has invented a new and useful invention entitled **METHOD FOR FABRICATING A THREE-DIMENSIONAL THIN-FILM SEMICONDUCTOR SUBSTRATE FROM A TEMPLATE**, for which an application for United States Letters Patent was made, said application filed with the U.S. Patent and Trademark Office on March 24, 2010, U.S. Application Serial No. 12/731,058; and

WHEREAS, Assignor believes himself to be the original inventor of the invention disclosed and claimed in said application for Letters Patent; and

WHEREAS, the parties desire to have a recordable instrument assigning their entire right, title and interest in and to said invention, said application and any Letters Patent that may be granted for said inventions in the United States and throughout the world;

NOW, THEREFORE, in accordance with the obligations to assign the invention and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Assignors sell, assign, and transfer to **SOLEXEL, INC.** (hereinafter referred to as "Assignee"), the entire right, title, and interest in and to said invention, said application and any Letters Patent that may be granted for said invention in the United States and throughout the world, including the right to file foreign applications directly in the name of the Assignee and to claim for any such foreign applications any priority rights to which such applications are entitled under international conventions, treaties, or otherwise.

Assignor agrees that, upon request and without further compensation, but at no expense to Assignor, and/or their legal representatives and assigns will do all lawful acts, including the execution of papers and the giving of testimony, that may be necessary or desirable for obtaining, sustaining, reissuing, or enforcing Letters Patent in the United States and throughout the world for said invention, and for perfecting, recording, or maintaining the title of Assignee, its successors and assigns, to said invention, said application, and any Letters Patent granted for said invention in the United States and throughout the world.

Assignor represents and warrants that he has not granted and will not grant to others any rights inconsistent with the rights granted herein.

Assignor authorizes and requests the Commissioner for Patents of the United States and of all foreign countries to issue any Letters Patent granted for said invention, whether on said

application or on any subsequently filed utility, divisional, continuation, continued prosecution application or reissue application, to Assignee, its successors and assigns, as the assignee of the entire interest in said invention.

IN WITNESS WHEREOF, Assignor has executed this Assignment on the date provided below.

FULL NAME OF FIRST INVENTOR:

David Xuan-Qi Wang

INVENTOR'S SIGNATURE:



DATE:

6/4/2010

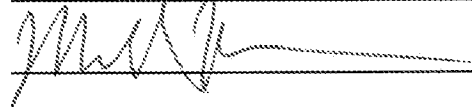
RESIDENCE:

41831 Via San Miguel, Fremont, CA 94539

Full Name Of Second Inventor:

Mehrdad M. Moslehi

Inventor's Signature:



Date:

7/2/2010

Residence:

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